

**GENERAL DESCRIPTION**

This document describes the specifications for the IDTF1100 Zero-Distortion™ RF to IF Downconverting Mixer. This device is part of a series of downconverting mixers covering all UTRA bands. See the Part# Matrix for the details of all devices in the series.

The F1100 dual channel device operates with a single 5V supply. It is optimized for operation in a Multi-carrier BaseStation Receiver for RF bands from 698 to 915 MHz with High Side Injection. IF frequencies from 150 to 450 MHz are supported. Nominally, the device offers +41 dBm Output IP3 with 350 mA of I<sub>CC</sub>.

**COMPETITIVE ADVANTAGE**

In typical basestation receivers the mixer limits the linearity performance for the entire receive system. The F1100 with Zero-Distortion technology dramatically improves the maximum IM<sub>3</sub> interference that the BTS can withstand at a desired Signal to Noise Ratio (SNR.)

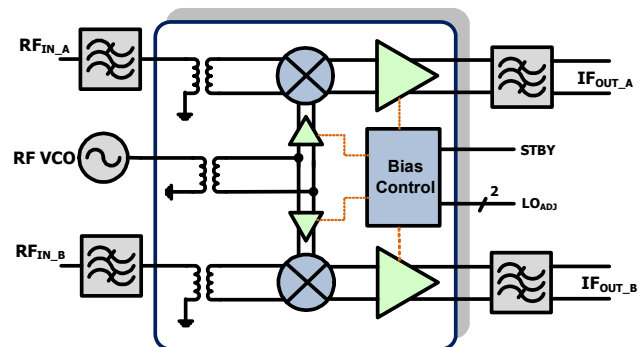
- ✓ IP<sub>3O</sub>: ↑ **7 dB**
- ✓ Allows for higher RF gain improving **Sensitivity**



**FEATURES**

- Dual Path for Diversity Systems
- Ideal for Multi-Carrier Systems
- MIMO friendly: -6 dBm min LO drive
- 9 dB Gain
- Ultra linear: +41 dBm IP<sub>3O</sub> (350 MHz IF)
- Low NF ~10 dB
- 200 Ω output impedance
- Ultra high +13 dBm P1dB<sub>I</sub>
- Pin Compatible w/Existing solutions
- 6x6 36 pin package
- Power Down mode
- Standard Mode: I<sub>CC</sub> = 350 mA

**DEVICE BLOCK DIAGRAM**

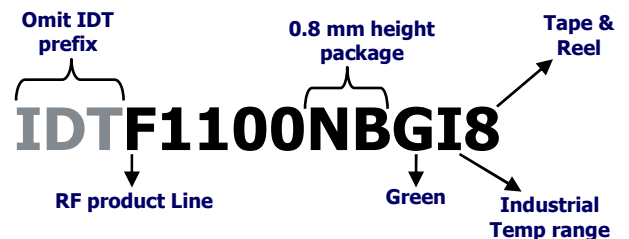


**PART# MATRIX**

Part#	RF freq range	UTRA bands	IF freq range	Typ. Gain	Injection
F1100	698 - 915	5,6,8,12,13,14,17,19,20	150 - 450	9	High Side
F1102	400 - 1000	5,6,8,12,13,14,17,19,20	50 - 300	9.0	Both
F1150	1700 - 2200	1,2,3,4,9,10, 33, 34,35, 36, 37,39	50 - 450	8.5	High Side
F1152	1400 - 2200	1,2,3,4,9,10, 21 <sup>1</sup> , 24 <sup>1</sup> , 33, 34,35, 36, 37,39	50 - 350	8.5	Low Side
F1162	2300 - 2700	7,38,40,41	50 - 500	8.8	Both

<sup>1</sup> - with High side injection

**ORDERING INFORMATION**



**ABSOLUTE MAXIMUM RATINGS**

VCC to GND	-0.3V to +5.5V
STBY	-0.3V to (VCC_ + 0.3V)
IF_A+, IF_B+, IF_A-, IF_B-, LO1_ADJ, LO2_ADJ	-0.3V to (VCC_ + 0.3V)
LO_IN, LO_IN_ALT, RF_A, RF_B	-0.3V to +0.3V
IF_BiasA, IF_BiasB to GND	-0.3V to +0.3V
RF Input Power (RF_A, RF_B)	+20dBm
Continuous Power Dissipation	2.2W
$\theta_{JA}$ (Junction – Ambient)	+35°C/W
$\theta_{JC}$ (Junction – Case) The Case is defined as the exposed paddle	+2.5°C/W
Operating Temperature Range (Case Temperature)	$T_C = -40^{\circ}\text{C}$ to $+100^{\circ}\text{C}$
Maximum Junction Temperature	150°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (soldering, 10s) .	+260°C

*Stresses above those listed above may cause permanent damage to the device. Functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.*

**IDTF1100 SPECIFICATION (698 – 915 MHz MIXER W/HIGH SIDE INJECTION)**

Specifications apply at  $V_{CC} = +5.0V$ ,  $F_{RF} = 850 \text{ MHz}$ ,  $F_{IF} = 350\text{MHz}$ , Hi-Side Inj.,  $P_{LO} = 0 \text{ dBm}$ ,  $T_{CASE} = +25^{\circ}\text{C}$ ,  $STBY = GND$ , Trace and Transformer Losses de-embedded unless otherwise noted.

Parameter	Comment	Symbol	min	typ	max	units
Logic Input High	For Standby Pin	$V_{IH}$	<b>2</b>			V
Logic Input Low	For Standby Pin	$V_{IL}$			<b>0.8</b>	V
Logic Current	For Standby Pin	$I_{IH}, I_{IL}$	<b>-5</b>		<b>+5</b>	$\mu\text{A}$
Supply Voltage(s)	All $V_{CC}$ pins	$V_{CC}$		4.75 to 5.25		V
Operating Temperature	Case Temperature	$T_{CASE}$		-40 to +100		degC
Supply Current	Total $V_{CC}$ Both Channels	$I_{STD}$		<b>350</b>	<b>395</b>	mA
Supply Current	Standby Mode <ul style="list-style-type: none"> <li>▪ <math>STBY = V_{IH}</math></li> <li>▪ Total Both Channels</li> </ul>	$I_{STBY}$		<b>28</b>	<b>35</b>	mA
RF Freq Range	Operating Range	$F_{RF}$		698 to 915		MHz
IF Freq Range	Operating Range	$F_{IF}$		150 to 450		MHz
LO Freq Range	Operating Range	$F_{LO}$		848 to 1365		MHz
LO Power	Operating Range	$P_{LO}$		-6 to +6		dBm
RF Input Impedance	Single Ended <i>Return Loss &gt; 15 dB</i>	$Z_{RF}$		50		$\Omega$
IF Output Impedance	Differential <i>Return Loss &gt; 15 dB</i>	$Z_{IF}$		200		$\Omega$
LO port Impedance	Single Ended <i>Return Loss &gt; 15 dB</i>	$Z_{LO}$		50		$\Omega$
Gain (low freq)	Conversion Gain <ul style="list-style-type: none"> <li>• <math>F_{RF} = 698 \text{ MHz}</math></li> <li>• <math>F_{IF} = 450 \text{ MHz}</math></li> <li>• EVB trace and transformer loss = 0.9 dB</li> </ul>	$G_1$	<b>7.8</b>	<b>8.9</b>	<b>10</b>	dB
Gain (high freq)	Conversion Gain <ul style="list-style-type: none"> <li>• <math>F_{RF} = 915 \text{ MHz}</math></li> <li>• <math>F_{IF} = 350 \text{ MHz}</math></li> <li>• EVB trace and transformer loss = 0.8 dB</li> </ul>	$G_2$	<b>8.0</b>	<b>9.0</b>	<b>10</b>	dB

**IDTF1100 SPECIFICATION (CONTINUED)**

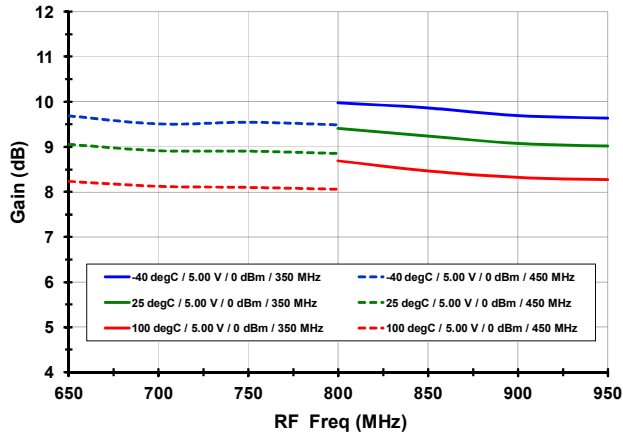
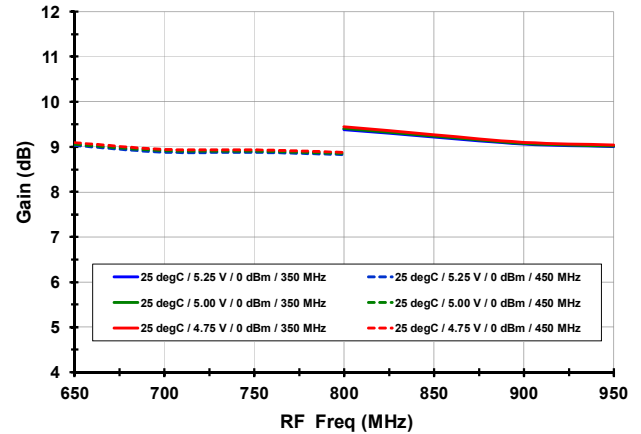
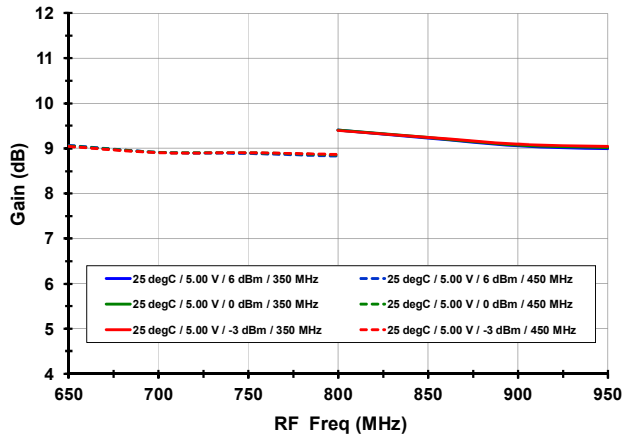
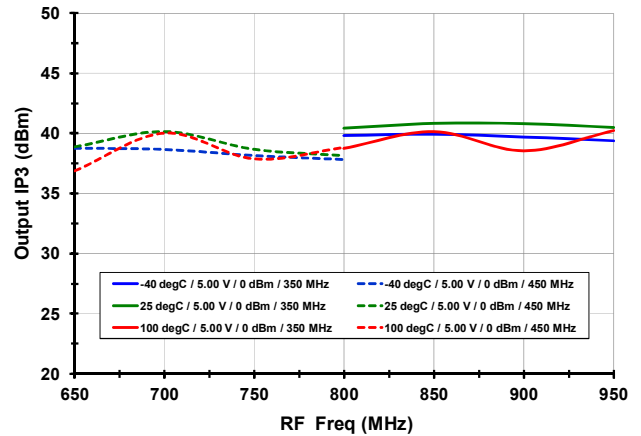
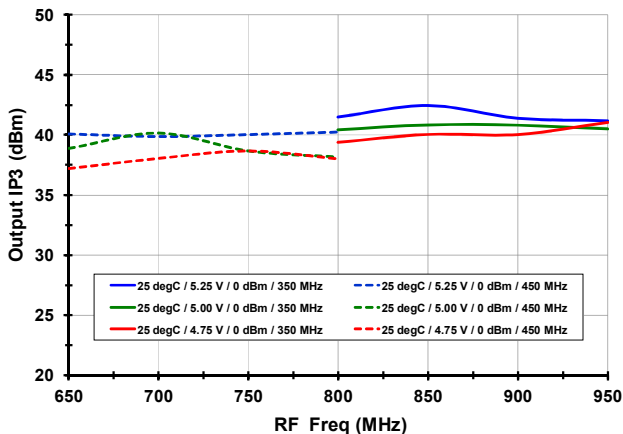
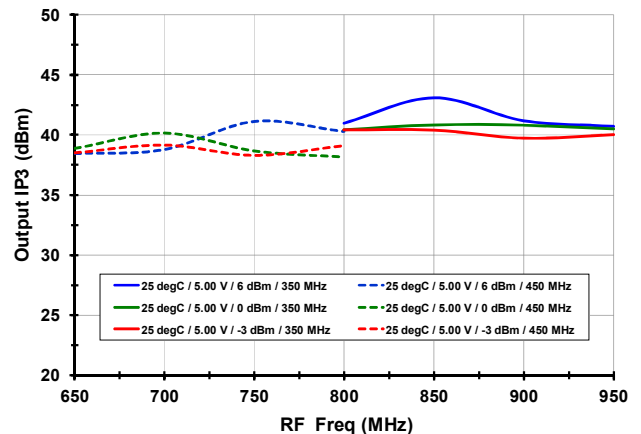
Parameter	Comment	Symbol	min	typ	max	units
Noise Figure	<ul style="list-style-type: none"> <li><math>F_{RF} = 850</math> MHz</li> <li><math>F_{IF} = 350</math> MHz</li> </ul>	$NF_{STD}$		10		dB
NF w/Blocker	<ul style="list-style-type: none"> <li>50 MHz offset blocker</li> <li><math>P_{IN} = +10</math> dBm</li> <li><math>F_{IF} = 350</math> MHz</li> <li><math>F_{RF} = 900</math> MHz</li> </ul>	$NF_{BLK}$		20.3		dB
Output IP3 – Narrowband	<ul style="list-style-type: none"> <li><math>P_{IN} = -10</math> dBm per tone</li> <li>800 KHz Tone Separation</li> <li><math>F_{IF} = 350</math> MHz</li> <li><math>F_{RF} = 850</math> MHz</li> </ul>	$IP3_{O1}$	38	41		dBm
Output IP3 – Wideband	<ul style="list-style-type: none"> <li><math>P_{IN} = -10</math> dBm per tone</li> <li>15 MHz Tone Separation</li> <li><math>F_{IF} = 350</math> MHz</li> </ul>	$IP3_{O2}$		41		dBm
2RF X 2LO rejection	<ul style="list-style-type: none"> <li><math>P_{RF} = -10</math> dBm</li> <li><math>F_{IF} = 350</math> MHz</li> <li><math>F_{LO} = 1200</math> MHz</li> <li><math>F_{SPUR} = F_{LO} - \frac{1}{2} F_{IF}</math></li> </ul>	2x2		-80		dBc
3RF X 3LO rejection	<ul style="list-style-type: none"> <li><math>P_{RF} = -10</math> dBm</li> <li><math>F_{IF} = 350</math> MHz</li> <li><math>F_{LO} = 1200</math> MHz</li> <li><math>F_{SPUR} = F_{LO} - \frac{1}{3} F_{IF}</math></li> </ul>	3x3		-82		dBc
1 dB Compression	<ul style="list-style-type: none"> <li>Input referred</li> <li><math>F_{IF} = 350</math> MHz</li> </ul>	$P1dB_I$	12.4	13.1		dBm
Channel Isolation	IF_B Pout vs. IF_A w/ RF_A input	$ISO_C$		60		dB
LO to IF leakage		$ISO_{LI}$		-19	-13	dBm
RF to IF leakage	$P_{in} = -10$ dBm	$ISO_{RI}$		-39	-33	dBm
LO to RF leakage		$ISO_{LR}$		-40		dBm

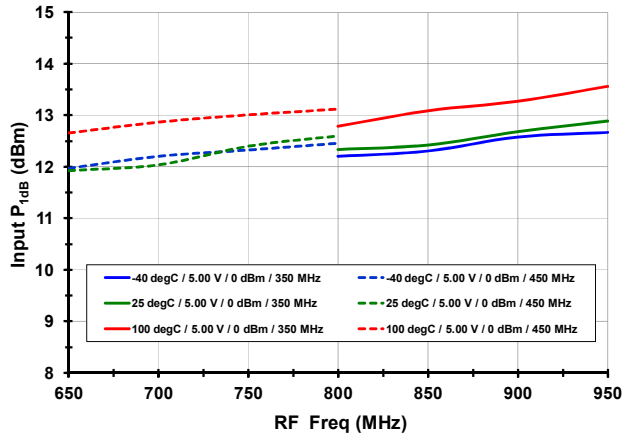
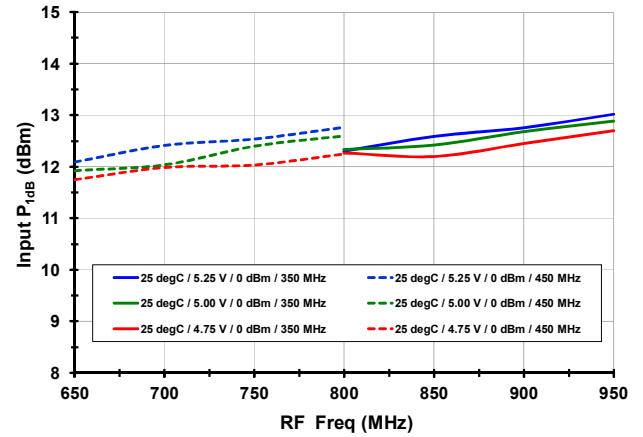
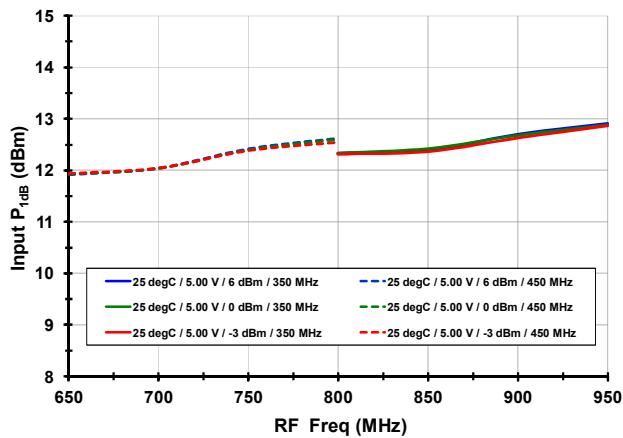
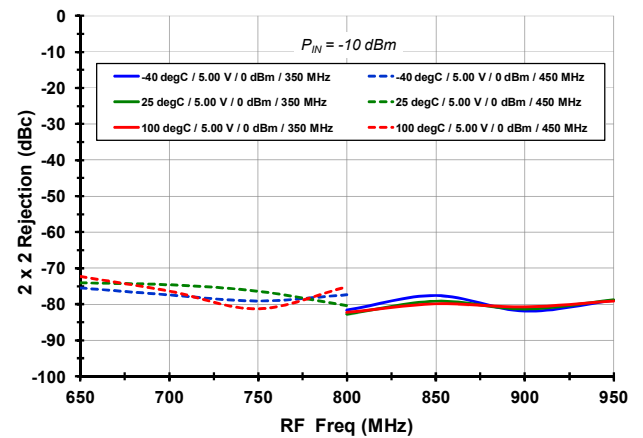
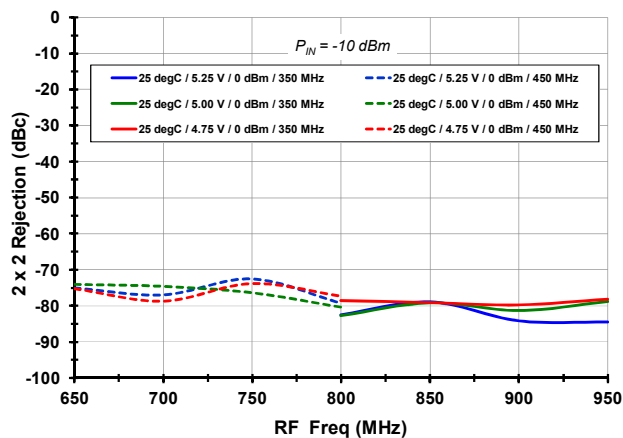
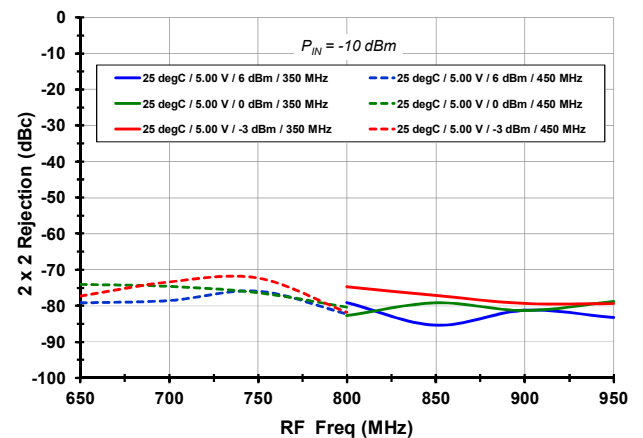
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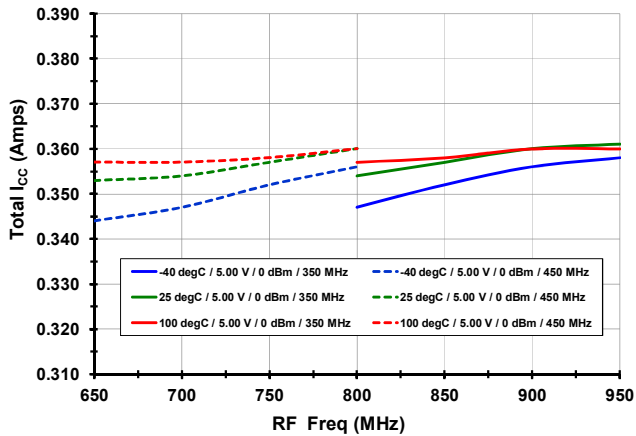
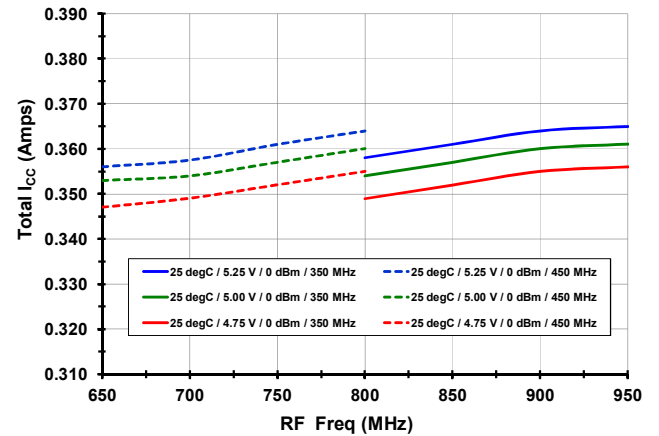
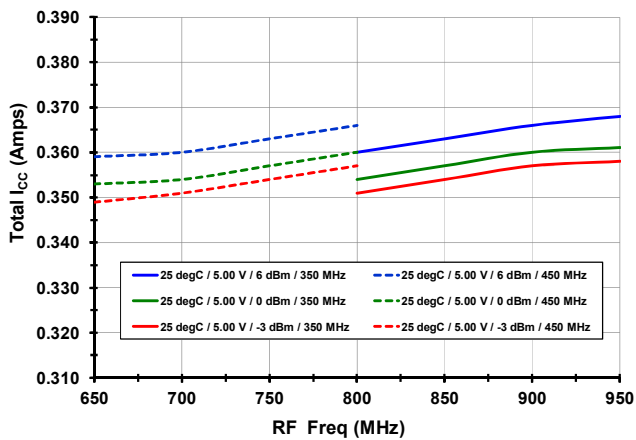
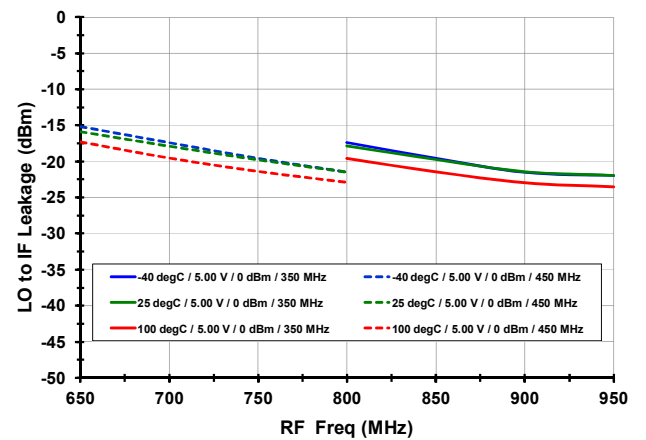
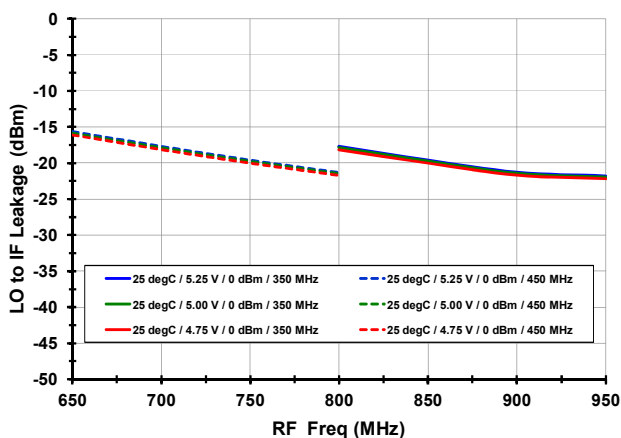
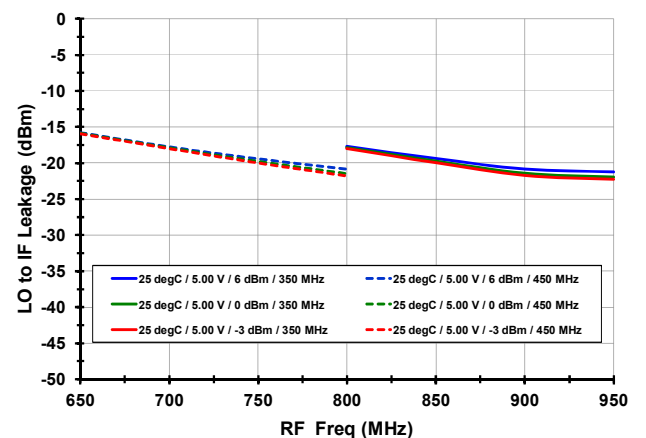
2 – All other Items in min/max columns are Guaranteed by Design Centering

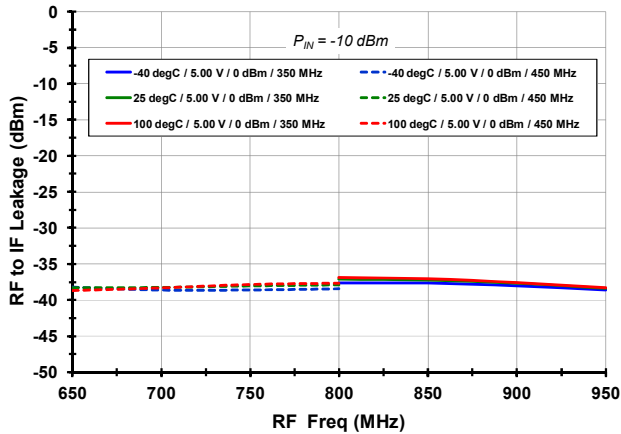
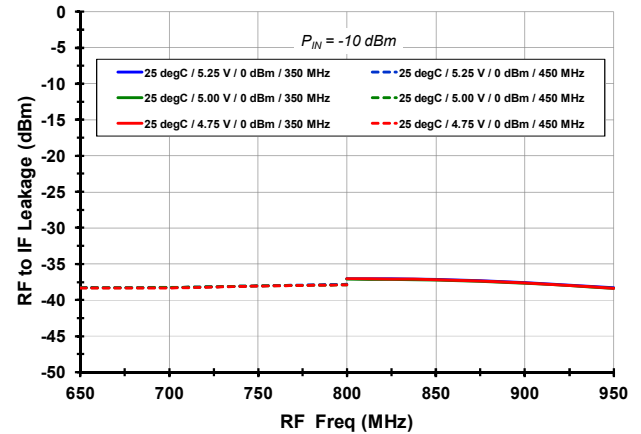
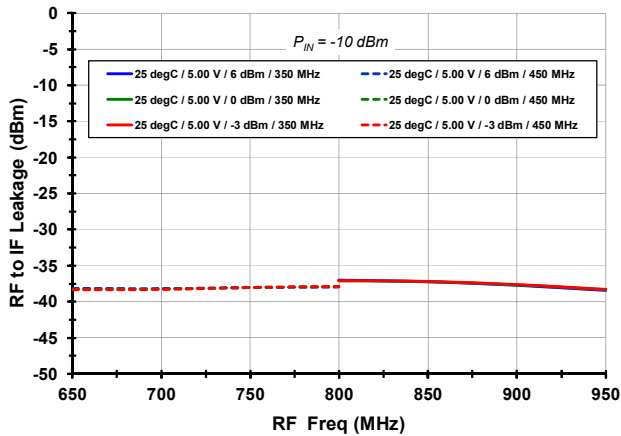
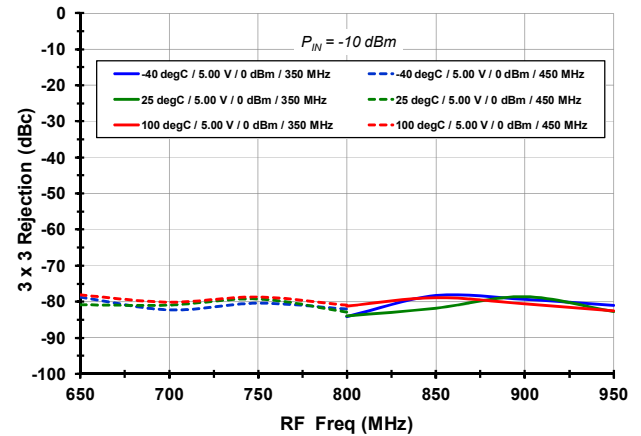
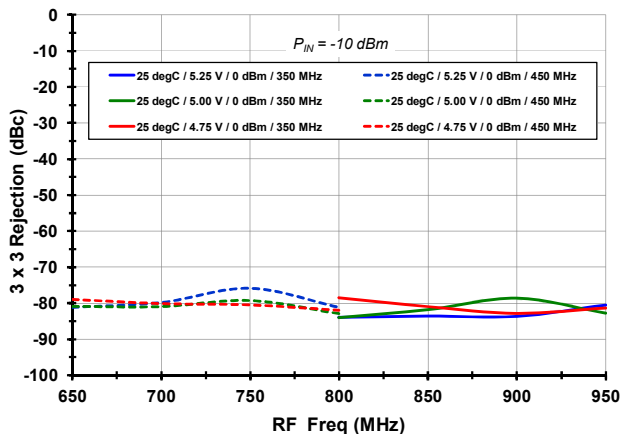
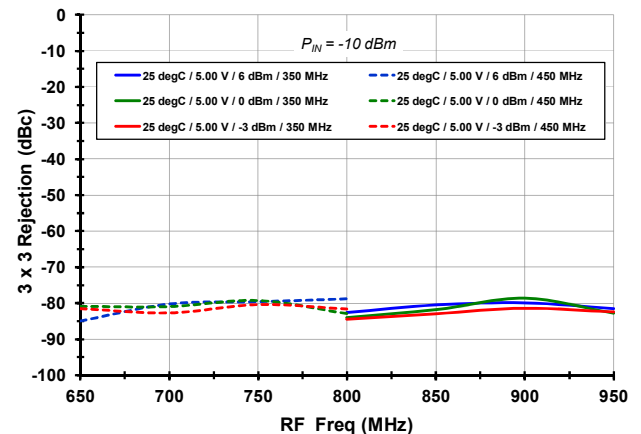
**TYPICAL OPERATING CONDITIONS**
**Unless Otherwise Noted:**

- Dotted Lines: 450 MHz IF / Solid Lines: 350 MHz IF
- High Side Injection
- 800 KHz Channel Spacing
- Average of ChA, ChB
- $P_{in} = -10$  dBm
- Trace & Transformer Losses de-embedded

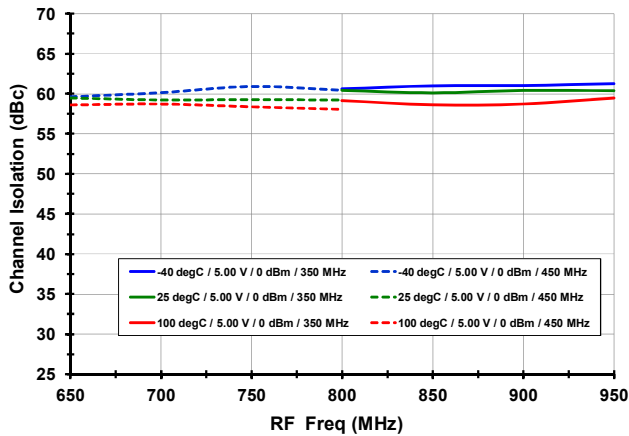
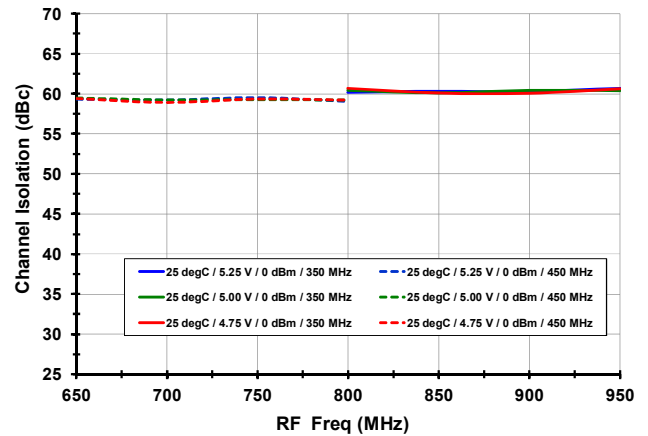
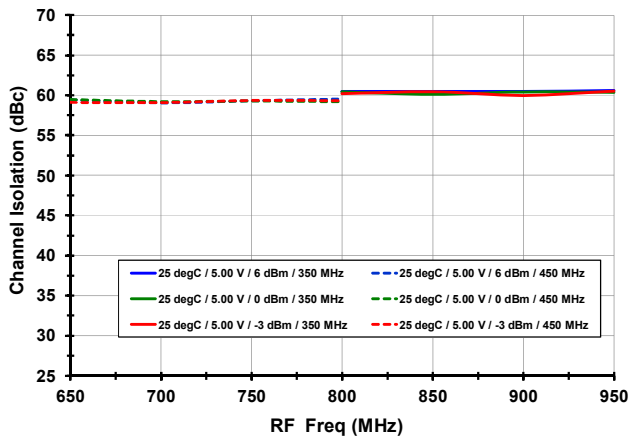
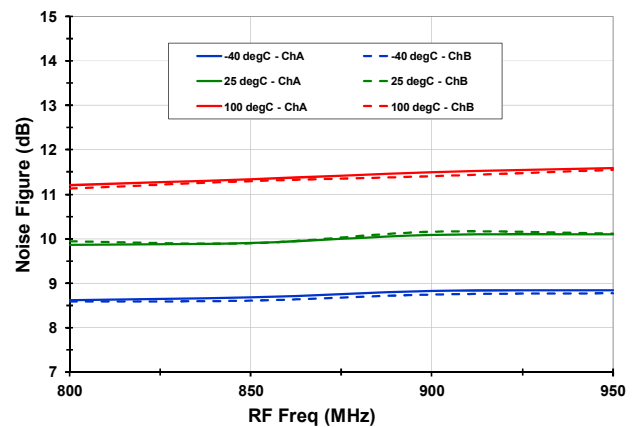
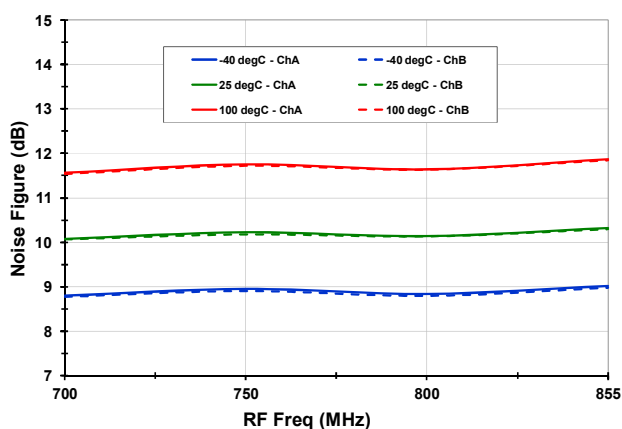
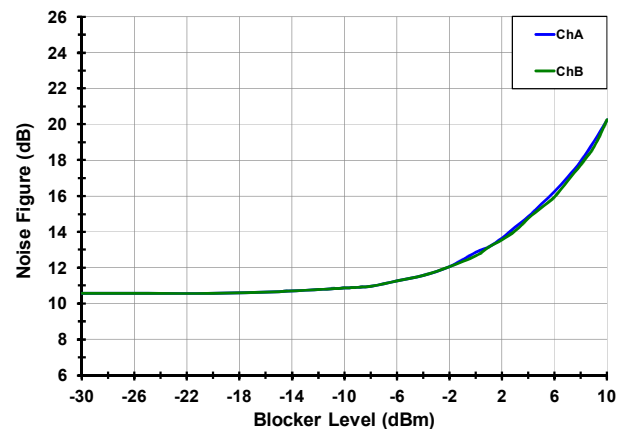
**TYPICAL OPERATING CONDITIONS (-1-)**
**Gain vs. T<sub>CASE</sub>**

**Gain vs. V<sub>CC</sub>**

**Gain vs. LO Level**

**Output IP3 vs. T<sub>CASE</sub>**

**Output IP3 vs. V<sub>CC</sub>**

**Output IP3 vs. LO Level**


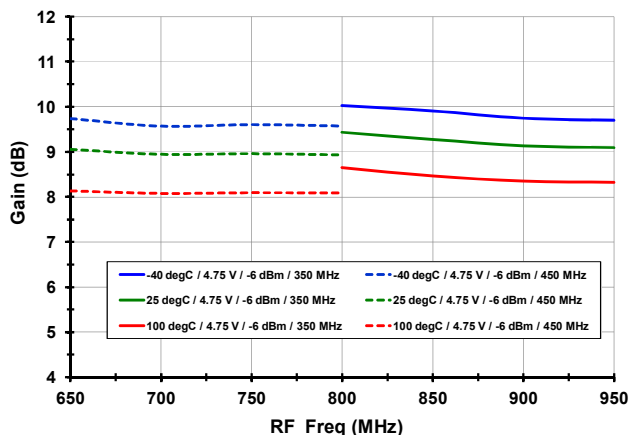
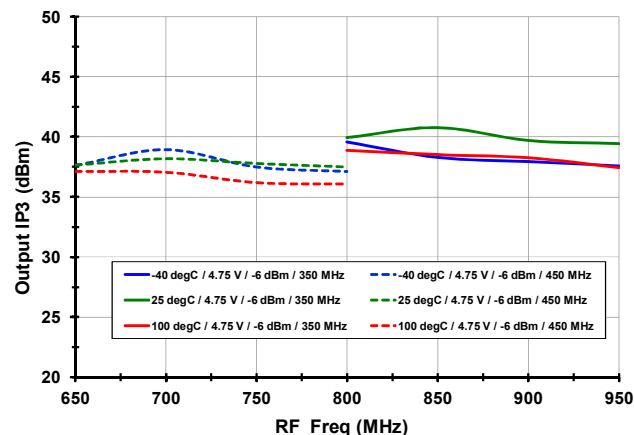
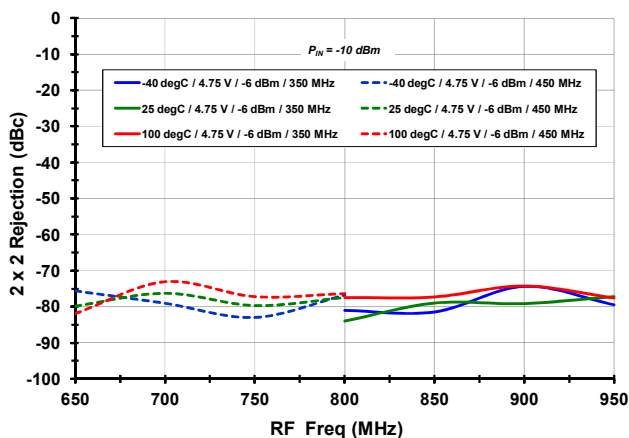
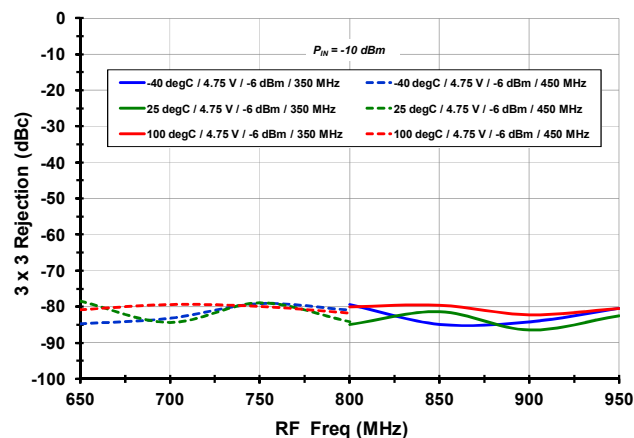
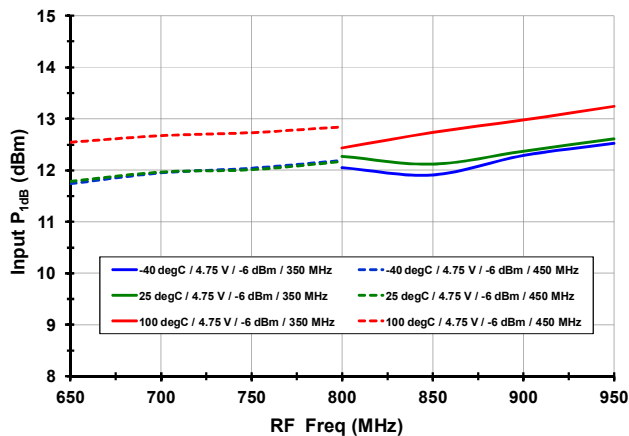
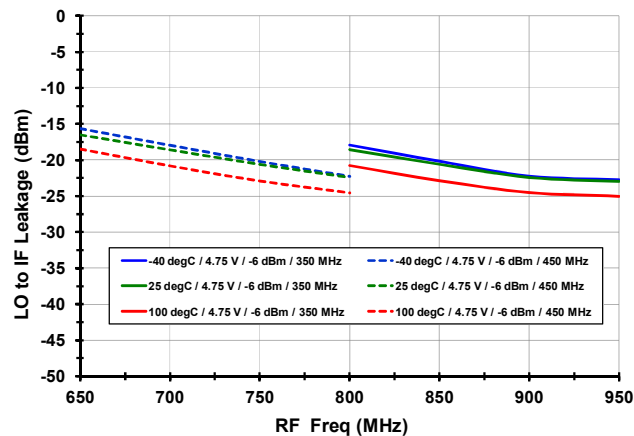
**TYPICAL OPERATING CONDITIONS (-2-)**
**P1dB vs. T<sub>CASE</sub>**

**P1dB vs. V<sub>CC</sub>**

**P1dB vs. LO Level**

**2RF x 2LO rejection vs. T<sub>CASE</sub>**

**2RF x 2LO Rejection vs. V<sub>CC</sub>**

**2RF x 2LO Rejection vs. LO Level**


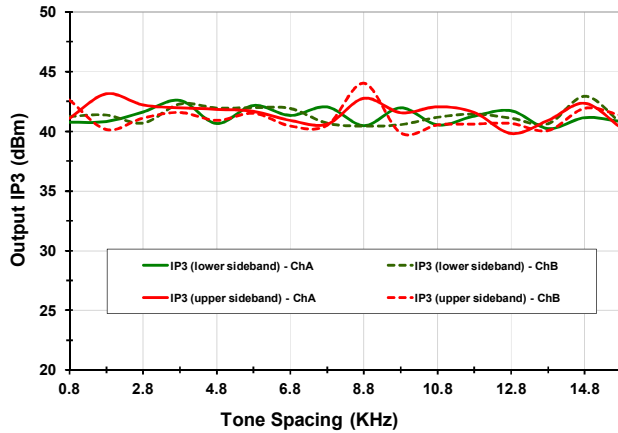
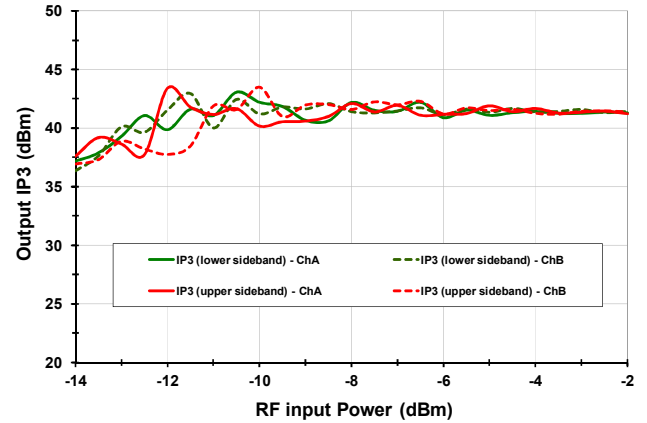
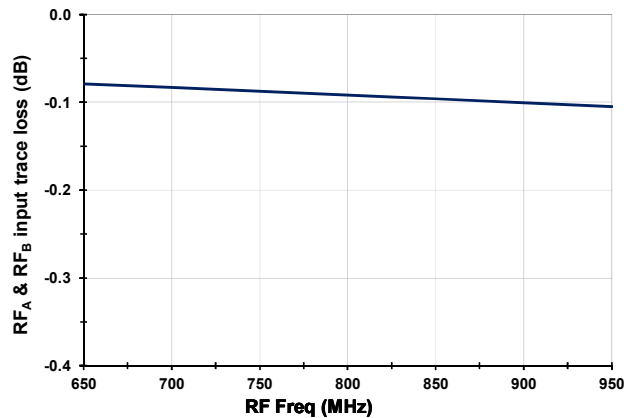
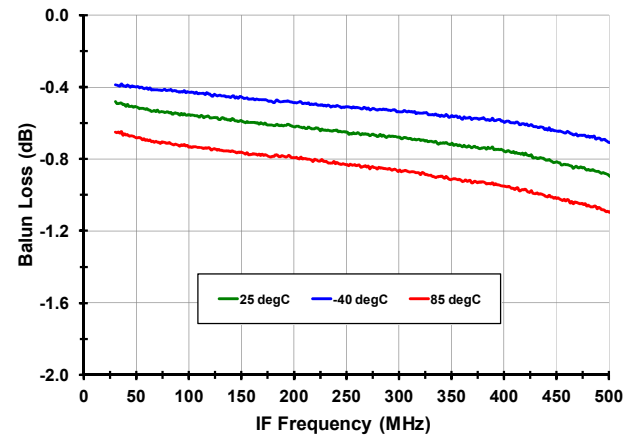
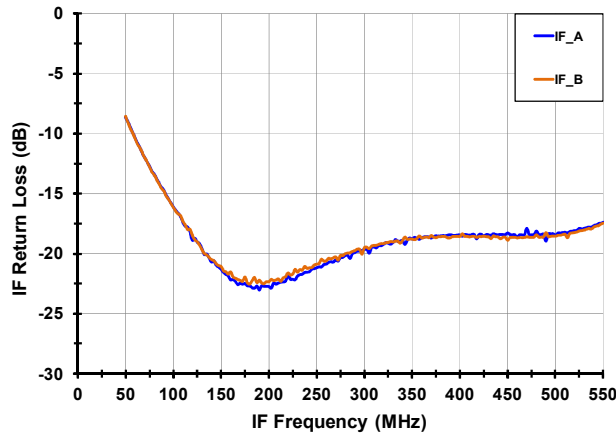
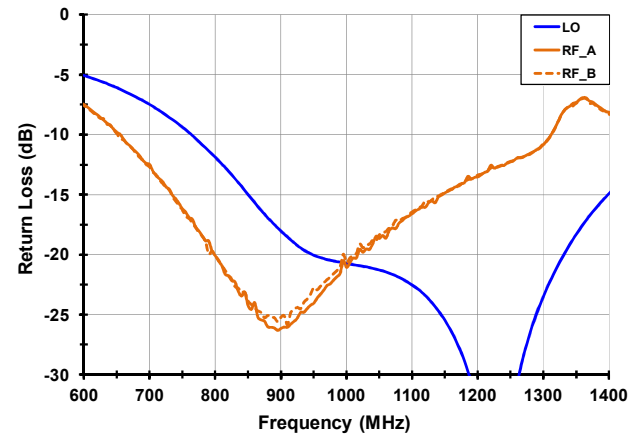
**TYPICAL OPERATING CONDITIONS (-3-)**
**I<sub>CC</sub> vs. T<sub>CASE</sub>**

**I<sub>CC</sub> vs. V<sub>CC</sub>**

**I<sub>CC</sub> vs. LO Level**

**LO-IF Leakage vs. T<sub>CASE</sub>**

**LO-IF Leakage vs. V<sub>CC</sub>**

**LO-IF Leakage vs. LO Level**


**TYPICAL OPERATING CONDITIONS (-4-)**
**RF-IF Leakage vs.  $T_{CASE}$** 

**RF-IF Leakage vs.  $V_{CC}$** 

**RF-IF Leakage vs. LO Level**

**3RF X 3LO Rejection vs.  $T_{CASE}$** 

**3RF X 3LO Rejection vs.  $V_{CC}$** 

**3RF X 3LO Rejection vs. LO Level**


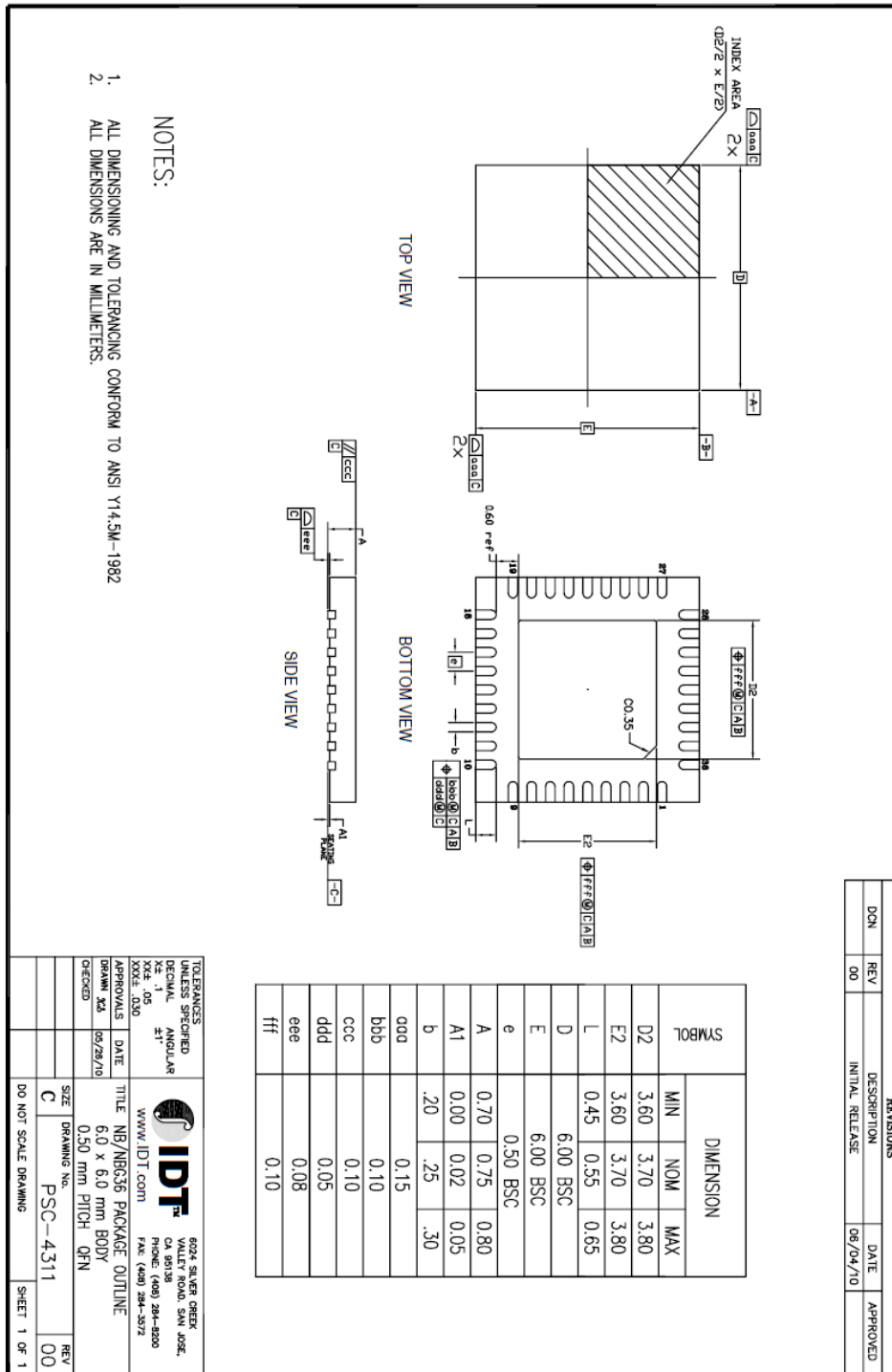


**TYPICAL OPERATING CONDITIONS (-5-)**
**Channel Isolation vs. T<sub>CASE</sub>**

**Channel Isolation vs. V<sub>CC</sub>**

**Channel Isolation vs. LO Level**

**Noise Figure vs. T<sub>CASE</sub> (350 MHz IF, RF trace de-embedded)**

**Noise Figure vs. T<sub>CASE</sub> (450 MHz IF, RF trace de-embedded)**

**NF vs. Blocker (RF = 900 MHz, IF = 350 MHz, T<sub>A</sub> = 25C)**


**RF to IF Dual Downconverting Mixer**
**698 - 915 MHz F1100NBGI**
**TYPICAL OPERATING CONDITIONS** [*Extreme Conditions: low Supply, low LO level -6 dBm*] **(-6-)**
**Gain**

**Output IP3**

**2x2 Rejection**

**3x3 Rejection**

**Input P1dB**

**LO to IF Leakage**


**TYPICAL OPERATING CONDITIONS [General] (-7-)**
**IP<sub>3O</sub> vs.  $\Delta f$  ( $T_A = 25C$ , Freq = 850 MHz, IF = 350 MHz)**

**IP<sub>3O</sub> vs. P<sub>IN</sub> ( $T_A = 25C$ , Freq = 850 MHz, IF = 350 MHz)**

**EVkit Input RF Trace Loss ( $T_A = 25C$ )**

**TC4-6T Transformer Loss**

**EVkit IF Port Match ( $T_A = 25C$ )**

**EVkit RF & LO Port Match ( $T_A = 25C$ )**


### PACKAGE DRAWING (6X6 QFN)



REVISIONS			
DCN	REV	DESCRIPTION	DATE
00	00	INITIAL RELEASE	08/04/10

TOLERANCES UNLESS SPECIFIED		6024 SILVER GREEK	
DECIMAL	ANGULAR	WALLET ROAD, SUITE 409E, COSTA MESA, CA 92626	
XXX .050	±1°	WWW.IDT.COM FAX: (408) 284-5972	
XX .1	±1°	TITLE NB/NBG56 PACKAGE OUTLINE	
XX .050	±1°	6.0 x 6.0 mm BODY	
APPROVALS	DATE	0.50 mm PITCH OPEN	
DRAWN XA	05/28/10	SIZE C	
CHECKED		DRAWING NO. PSC-4311	
		DO NOT SCALE DRAWING	
		SHEET 1 OF 1	

## PINOUTS

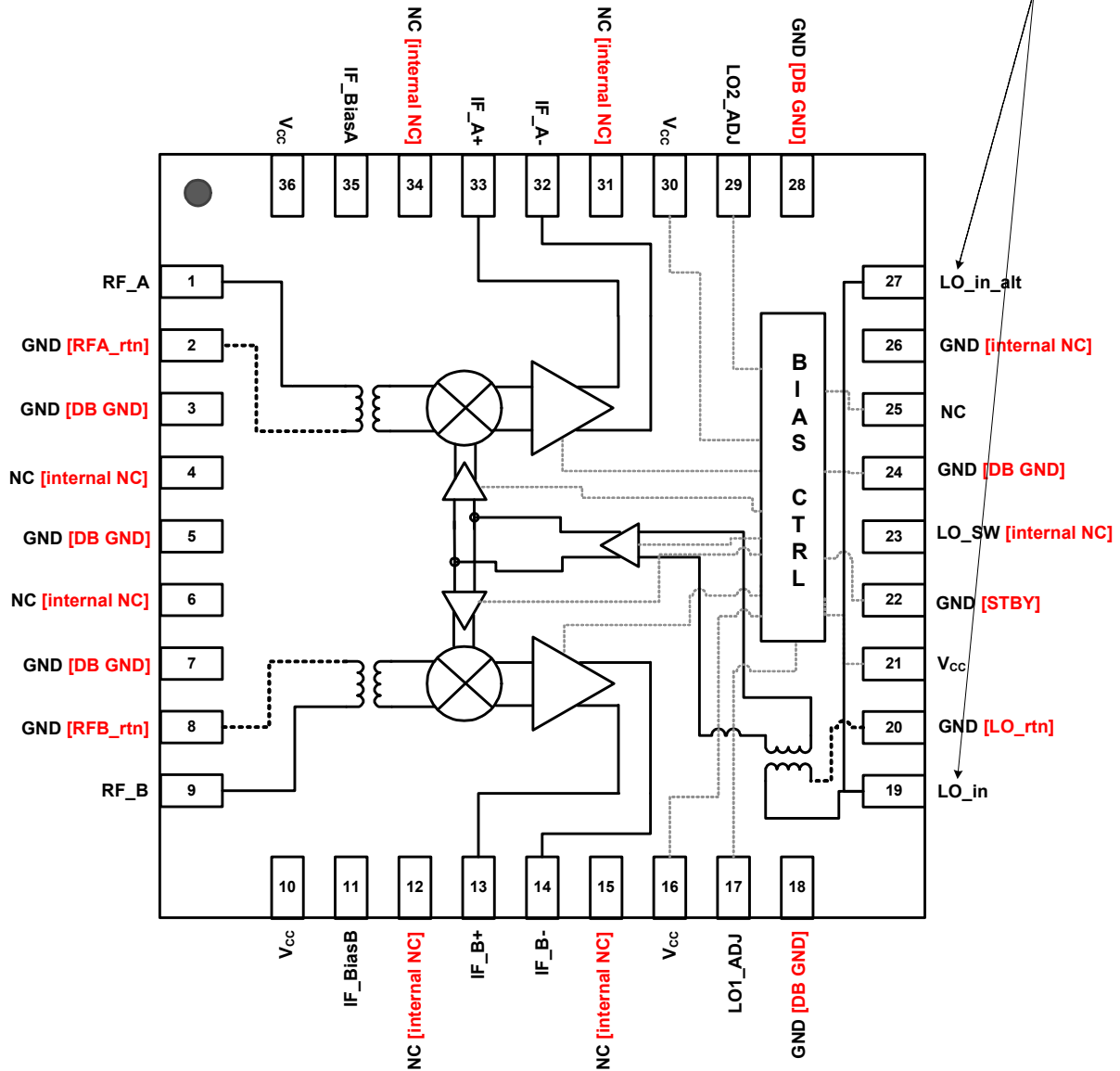
Black Text denotes recommended external connection

Red Text denotes internal Function or Connection

- DB GND = Downbonded to Paddle
- Internal NC = Pin not connected

### Please Note!

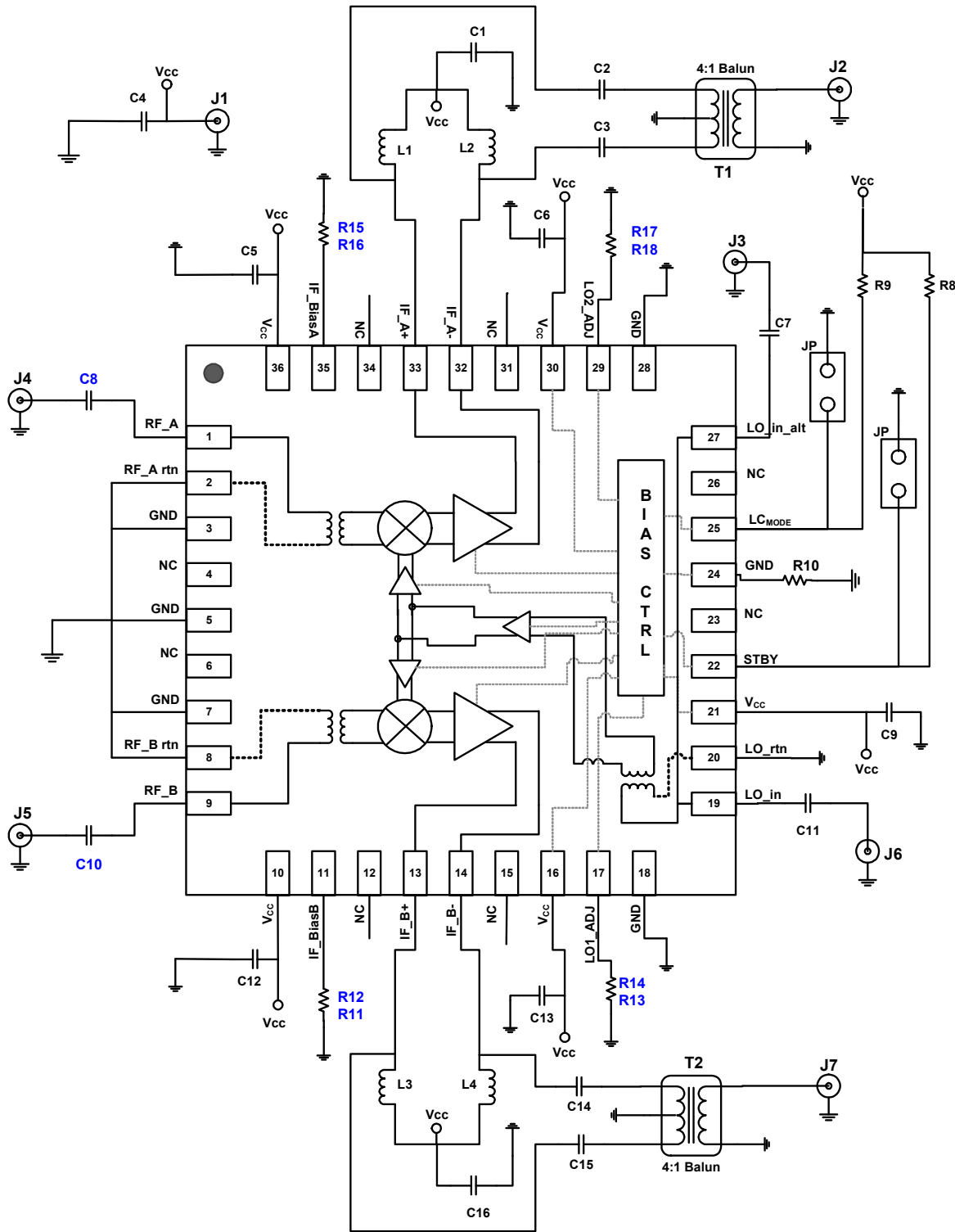
- Only connect to one LO feed
- Choose Either Pin 19 or Pin 27
- Do not connect the unused LO pin to ensure good LO return loss



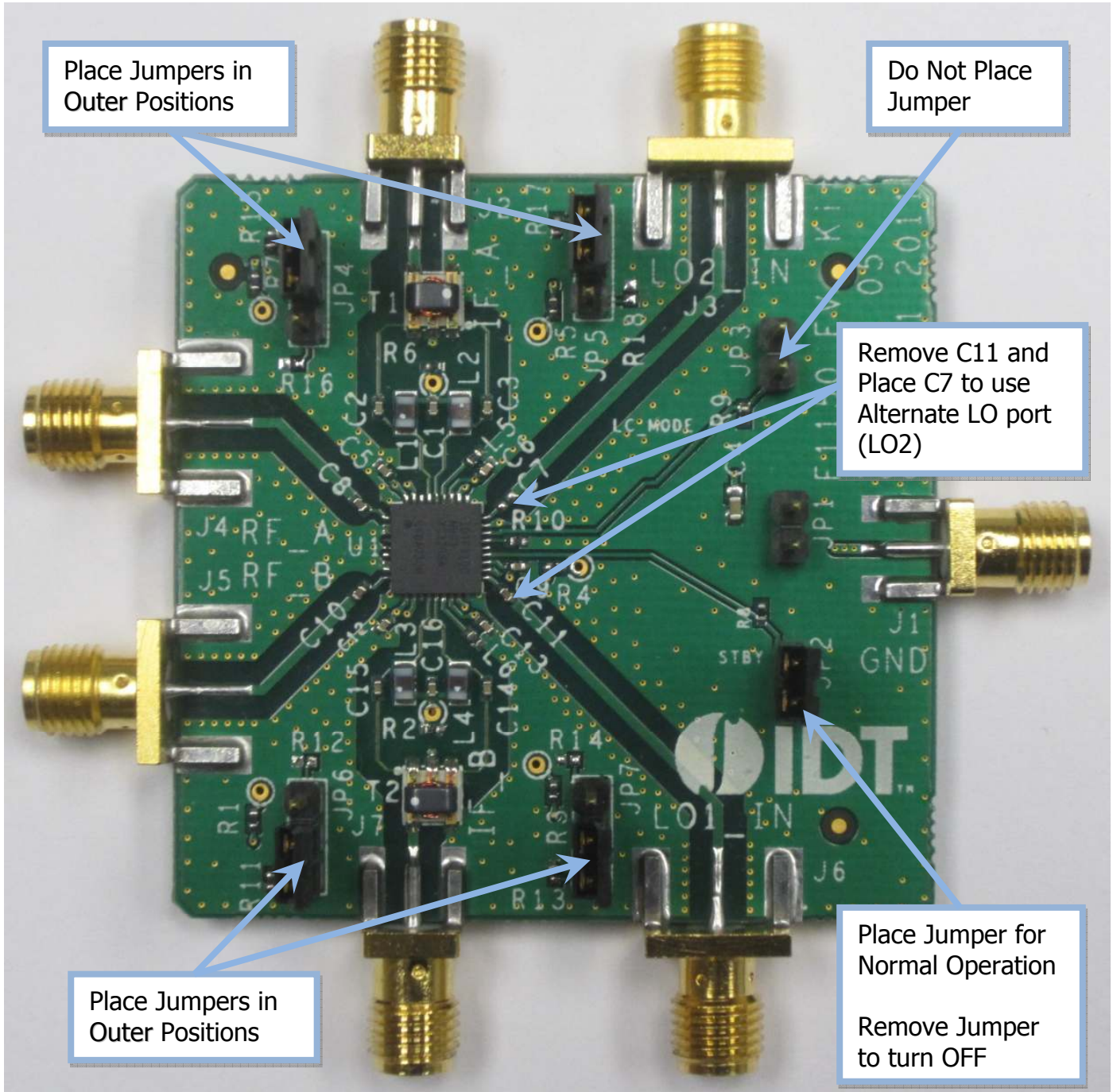
**PIN DESCRIPTIONS**

Pin	Name	Function
1	RF_A	Main Channel RF Input. Internally matched to 50Ω. DO NOT apply DC to these pins
2, 8, 20	RF_Artn, RF_Brtn, LO_rtn	Transformer Ground Returns. Ground these pins.
3, 5, 7, 18, 24, 28	GND	Ground these pins.
4, 6, 12, 15, 31, 23, 26, 34	N.C.	No Connection. Not internally connected. OK to connect to Vcc. OK to connect to GND
10, 16, 21, 30, 36	VCC	Power Supply. Bypass to GND with capacitors shown in the Typical Application Circuit as close as possible to pin.
9	RF_B	Diversity Channel RF Input. Internally matched to 50Ω
11	IF_BiasB	Connect the specified resistor from this pin to ground to set the bias for the Diversity IF amplifier. This is NOT a current set resistor
13, 14	IFB+, IFB-	Diversity Mixer Differential IF Output. Connect pullup inductors from each of these pins to VCC (see the Typical Application Circuit).
17	LO1_ADJ	Connect the specified resistor for either Standard or LC mode from this pin to ground to set the LO common buffer Icc
19, 27	LO_in LO_in_alt	Local Oscillator Input. Connect the LO to this port through the recommended coupling capacitor. <b>Note that you can only drive one LO port at a time. Remove the series capacitor from the unused port.</b>
25	NC	Make Certain this pin is not connected. It is normally reserved for selecting <i>low current</i> mode which the F1100 does not offer
22	STBY	STBY Mode. Pull this pin high for Standby mode (~28 mA). Pull low or Ground for normal Operation
29	LO2_ADJ	Connect the specified resistor for either Standard or LC mode from this pin to ground to set the LO drive buffers Icc
32, 33	IFA-, IFA+	Main Mixer Differential IF Output. Connect pullup inductors from each of these pins to VCC (see the Typical Application Circuit).
35	IF_BiasA	Connect the specified resistor from this pin to ground to set the bias for the Main IF amplifier. This is NOT a current set resistor
	— EP	Exposed Pad. Internally connected to GND. Solder this exposed pad to a PCB pad that uses multiple ground vias to provide heat transfer out of the device into the PCB ground planes. These multiple via grounds are also required to achieve the noted RF performance.

#### EVKIT SCHEMATIC



**EVKIT PICTURE/LAYOUT/OPERATION**





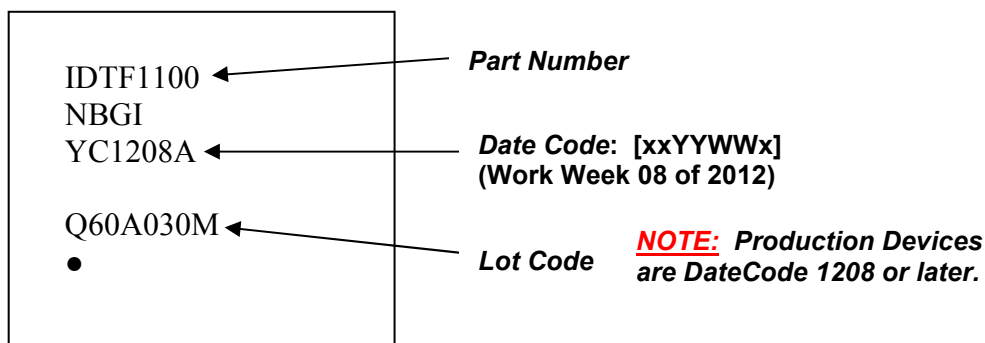
**EVKIT BOM**

For Normal Operation, Make sure the LC<sub>MODE</sub> jumper is open and that the dual jumpers are set to the outer position.

**F1100 PCB Rev 5 BOM Rev 02**

Item #	Value	Size	Desc	Mfr. Part #	Mfr.	Part Reference	Qty
1	10nF	0402	CAP CER 10000PF 16V 10% X7R 0402	GRM155R71C103KA01D	MURATA	C1,5,6,9,12,13,16	7
2	1000pF	0402	CAP CER 1000PF 50V C0G 0402	GRM1555C1H102JA01D	MURATA	C2,3,14,15	4
3	150pF	0402	CAP CER 150PF 50V C0G 0402	GRM1555C1H151JA01D	MURATA	C8,10,11	3
4	150pF		<b>NOTE: C7 and C11 cannot be installed together. C7 for Pin27 LO feed. C11 for Pin19 LO feed</b>			C7	1
5	10uF	0603	CAP CER 10UF 6.3V X5R 0603	GRM188R60J106ME47D	MURATA	C4	1
6	Header 2 Pin	TH 2	CONN HEADER VERT SGL 2POS GOLD	961102-6404-AR	3M	JP1,2,3	3
7	Header 3 Pin	TH 3	CONN HEADER VERT SGL 3POS GOLD	961103-6404-AR	3M	JP4,5,6,7	4
8	SMA_END_LAUNCH	.062	SMA_END_LAUNCH (Small)	142-0711-821	Emerson Johnson	J1,2,7	3
9	SMA_END_LAUNCH	.062	SMA_END_LAUNCH (Big)	142-0701-851	Emerson Johnson	J3,4,5,6	4
10	270nH	0805	0805CS (2012) Ceramic Chip Inductor	0805CS-271XJLB	COILCRAFT	L1,2,3,4	4
11	20	0402	RES 20 OHM 1/10W 1% 0402 SMD	ERJ-2RKF27R0X	Panasonic	R11,15	2
12	40.2	0402	RES 40.2 OHM 1/10W 1% 0402 SMD	ERJ-2RKF40R2X	Panasonic	R13	1
13	1.21K	0402	RES 1.21K OHM 1/10W 1% 0402 SMD	ERJ-2RKF1211X	Panasonic	R17	1
14	47K	0402	RES 47.0K OHM 1/16W 1% 0402 SMD	RC0402FR-0747KL	Yageo	R8,9	2
15	0	0402	RES 0.0 OHM 1/10W 0402 SMD	ERJ-2GE0R00X	Panasonic	R1,2,3,4,5,6,7,10	8
16	4:1 Balun	SM-22	4:1 Center Tap Balun	TC4-6TG2+	Mini Circuits	T1,2	2
17	F1100	QFN-36	DUAL RF MIXER	F1100NBGI	IDT	U1	1
18	PCB		EV Kit	F11XXEV Kit Rev 05			1

**Total 52**

**TOPMARKINGS**


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